TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC4511AP,TC74HC4511AF

BCD-to-7 Segment Latch/Decoder/Driver

The TC74HC4511A is a high speed CMOS BCD-TO-7 SEGMENT LATCH/DECODER/DRIVER fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The segment output driver, which is of CMOS construction, has a large IOH capability which permits the device to drive cathode common LED directly.

When lamp test (LT) is held low, all segment outputs will go high, and when the blanking input (BI) is held low and LT is held high, all segment outputs will go low. These functions are independent of other inputs and used to test the display.

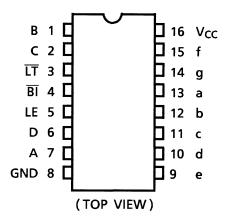
BI is used to pulse - modulate the brightness of the display. When error code (over 10) is applied to BCD inputs, all segment outputs will go to low (turn off).

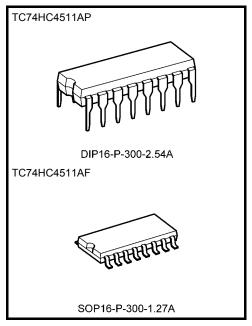
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 28 \text{ ns}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25^{\circ}C$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I_{OH}| = 20 mA
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with TC4511B

Pin Assignment

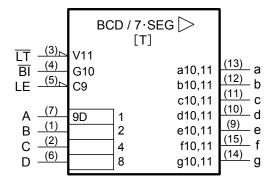




Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

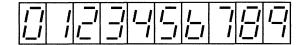
IEC Logic Symbol



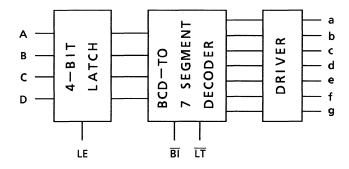
[T]: Truth Table

Display Mode





Block Diagram



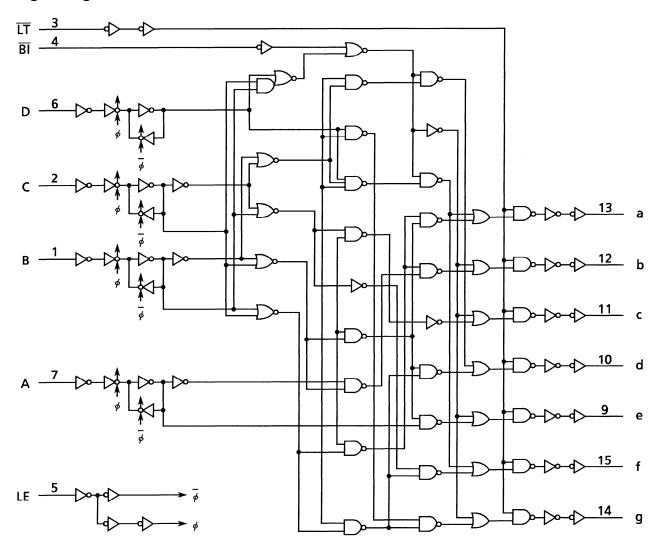


Truth Table

	Inputs Outputs						Display							
LE	BI	ĪΤ	D	С	В	Α	а	b	С	d	е	f	g	Mode
*	*	L	*	*	*	*	Н	Н	Н	Н	Н	Н	Н	8
*	L	Н	*	*	*	*	L	L	L	L	L	L	L	Blank
L	Н	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	L	0
L	Н	Н	L	L	L	Н	L	Н	Н	L	L	L	L	1
L	Н	Н	L	L	Н	L	Н	Н	L	Н	Н	L	Н	2
L	Н	Н	L	L	Н	Н	Н	Н	Н	Н	L	L	Н	3
L	Н	Н	L	Н	L	L	L	Н	Н	L	L	Н	Н	4
L	Н	Н	L	Н	L	Н	Н	L	Н	Н	L	Н	Н	5
L	Н	Н	L	Н	Н	L	L	L	Н	Н	Н	Н	Н	6
L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	L	L	L	7
L	Н	Н	Н	L	L	L	Н	Н	Н	Н	Н	Н	Н	8
L	Н	Н	Н	L	L	Н	Н	Н	Н	L	L	Н	Н	9
L	Н	Н	Н	L	Н	*	L	L	L	L	L	L	L	Blank
L	Н	Н	Н	Н	*	*	L	L	L	L	L	L	L	Blank
Н	Н	Н	*	*	*	*	Hold th	e stage	at the le	ading ed	dge of L	E		

^{*:} Don't care

Logic Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	٧
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	+25 (sinc)/-35 (source)	mA
DC V _{CC} /ground current	Icc	+150 (I _{CC})/–50 (I _{GND})	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65° C. From Ta = 65 to 85° C a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	٧
Output voltage	V _{OUT}	0 to V _{CC}	>
Operating temperature	T _{opr}	−40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.



Electrical Characteristics

DC Characteristics

Characteristics	Symbol	1 1 1 1 1 1 1 1 1 1				–40 to s°C	Unit			
Onaracteristics	Cymbol				Min	Тур.	Max	Min	Max	Offic
				2.0	1.50	_	_	1.50	_	
High-level input voltage	V _{IH}		_		3.15	_	_	3.15	_	V
ŭ				6.0	4.20		_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V _{IL}		_	4.5	_		1.35	— 1.35		٧
ŭ							1.80	_	1.80	
				2.0	1.9	2.0	_	1.9	_	
			I _{OH} = -20 μA	4.5	4.4	4.5	_ 4	4.4	_	
High-level output	V _{OH}	V _{IN} = V _{IH} or		6.0	5.9	6.0	_	5.9	_	V
voltage	VOH	VIL VIH OI	$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31		4.13		V
			I _{OH} = -20 mA	4.5	3.20	3.80		2.90		
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80		5.63		
				2.0	_	0.0	0.1	_	0.1	
		V _{IN}	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V_{OL}	= V _{IH} or		6.0	_	0.0	0.1	_	0.1	V
		V _{IL}	I _{OL} = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0			±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{C}$	_C or GND	6.0	_	_	4.0	_	40.0	μА

Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta =	25°C	Ta = -40 to 85°C	Unit	
			V _{CC} (V)	Тур.	Limit	Limit		
Minimum pulse width			2.0	_	75	95		
(LE)	t _{W (L)}	_	4.5	_	15	19	ns	
(LE)			6.0	_	13	16		
			2.0	_	75	95		
Minimum set-up time	ts	_	4.5	_	15	19	ns	
			6.0	_	13	16		
			2.0	_	0	0		
Minimum hold time	t _h	_	4.5	_	0	0	ns	
			6.0	_	0	0		



AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: t_r = t_f = 6 ns)

Characteristics	Symbol	bol Test Condition		Тур.	Max	Unit
Output transition time	t _{TLH}	_	_	4	8	ns
Output transition time	t _{THL}	_	_	4	8	ns
Propagation delay time	t _{pLH}			28	45	ns
(BCD-segment)	t _{pHL}	_		20	45	115
Propagation delay time	t _{pLH}			18	31	ns
(BI -segment)	t _{pHL}			10	31	115
Propagation delay time	t _{pLH}			12	21	ns
(LT -segment)	t _{pHL}	_		12	21	115
Propagation delay time	t _{pLH}			26	44	ns
(LE-segment)	t _{pHL}			20	44	115

AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		-	Ta = 25°C		Ta = - 85	Unit	
Characteristics	Cymbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
			2.0	_	25	60	_	75	
Output transition time low to high	t _{TLH}	_	4.5	_	7	12	_	15	ns
i i i i i i i i i i i i i i i i i i i			6.0	_	6	11	_	13	
			2.0	_	30	75	_	95	
Output transition time high to low	t _{THL}	_	4.5	_	8	15	_	19	ns
g 15 15 11			6.0		7	13	_	16	
Propagation delay	4		2.0	_	125	255	_	320	
time	t _{pLH}	_	4.5	_	33	51	_	64	ns
(BCD-segment)	t_{pHL}		6.0	_	23	43	_	54	
Propagation delay	4		2.0	_	70	175	_	220	
time	t _{pLH}	_	4.5	_	22	35	_	44	ns
(BI -segment)	t _{pHL}		6.0	_	17	30	_	37	
Propagation delay	4		2.0	_	60	120	_	150	
time	t _{pLH}	_	4.5	_	15	24	_	30	ns
(LT -segment)	t _{pHL}		6.0	_	12	20	_	26	
Propagation delay			2.0	_	95	240	_	300	
time	t _{pLH}	_	4.5	_	32	48	_	60	ns
(LE-segment)	t _{pHL}		6.0	_	23	41	_	51	
Input capacitance	C _{IN}	_			5	10		10	pF
Power dissipation	C _{PD}				95				pF
capacitance	(Note)	_			ອວ				рг

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

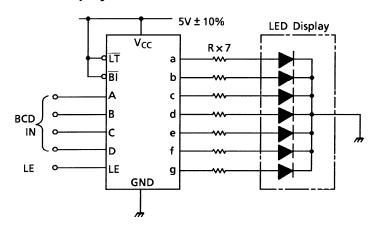
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$



Application Circuit

Static Display Circuit

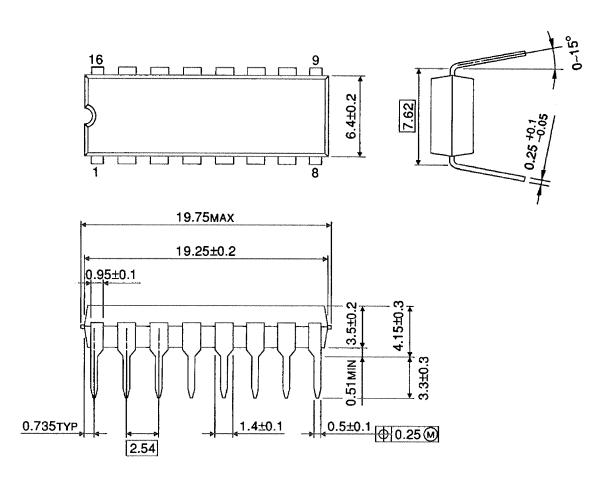


Recommended Resistance R

Display	Color	Letter Hight	R
TLR358T	Red	13.4 mm	390 Ω
TLR362T	Red	14.2	390 Ω
TLR332T	Red	7.6	390 Ω
TLR342T	Red	10.9	390 Ω
TLG358T	Green	13.4 mm	160 Ω
TLG362T	Green	14.2	160 Ω
TLG332T	Green	7.6	160 Ω
TLG342T	Green	10.9	160 Ω

Package Dimensions

DIP16-P-300-2.54A Unit: mm

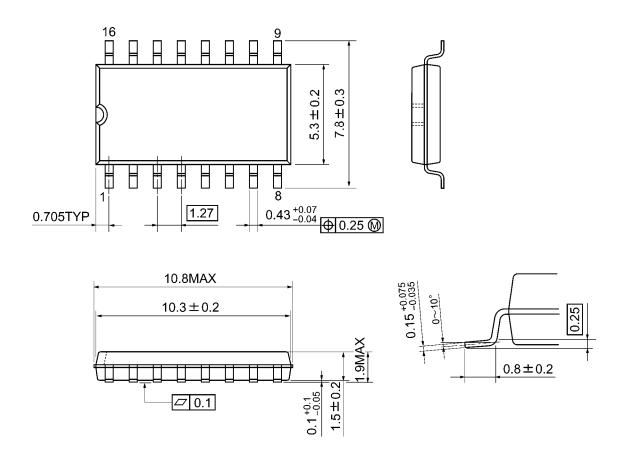


Weight: 1.00 g (typ.)



Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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